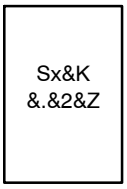
Full-Function Load Switch with Adjustable Current Limit

FPF2193, FPF2194, FPF2195



WLCSP6 1.48x0.98x0.582
CASE 567RN

MARKING DIAGRAM



Sx = Device Code (x = 6, 7, 9, Y)
&K = 2-Digits Lot Run Traceability Code
&. = Pin One Dot
&2 = 2-Digit Date Code
&Z = Assembly Plant Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 13 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 13.

Description

The FPF2193, FPF2194, and FPF2195 form a series of load switches that provides full protection to systems and loads that may encounter large current conditions. These devices contain a 55 mΩ current-limited P-channel MOSFET that can operate over an input voltage range of 1.8 to 5.5 V. Internally, current is prevented from flowing when the MOSFET is off and the output voltage is higher than the input voltage. Switch control is by a logic input (ON) capable of interfacing directly with low-voltage control signals. Each part contains thermal shutdown protection that shuts off the switch to prevent damage to the part when a continuous over-current condition causes excessive heating.

When the switch current reaches the current limit, the parts operate in a constant-current mode to prohibit excessive currents from causing damage. For the FPF2193 and FPF2194, if the constant current condition still persists after 30 ms, the parts shut off the switch and pull the fault signal pin (FLAGB) LOW. The FPF2193 has an auto-restart feature that turns the switch on again after 450 ms if the ON pin is still active. The FPF2194 does not have this auto-restart feature, so the switch remains off until the ON pin is cycled. The FPF2195 does not turn off after a current limit fault, but remains in the constant-current mode indefinitely. The minimum current limit can be set as low as 45 mA.

These parts are available in a space-saving six ball advanced 0.98 x 1.48 mm WLCSP package.

Features

- <1.8 to 5.5 V Input Voltage Range
- Controlled Turn-On
- 0.1 to 1.5 A Adjustable Current Limit
- Under-Voltage Lockout
- Thermal Shutdown
- <2 μA Shutdown Current
- Auto Restart
- Fast Current Limit Response Time
- 5 μs to Moderate Over Currents
- 30 ns to Hard Shorts
- Fault Blanking
- Reverse Current Blocking

Applications

- PDAs
- Cell Phones
- Handheld GPS Devices
- Portable Enterprise / Industrial Devices
- Digital Cameras
- Peripheral Ports and Accessories
- Portable Medical Equipment
- Hot Swap Supplies

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APPLICATION DIAGRAM

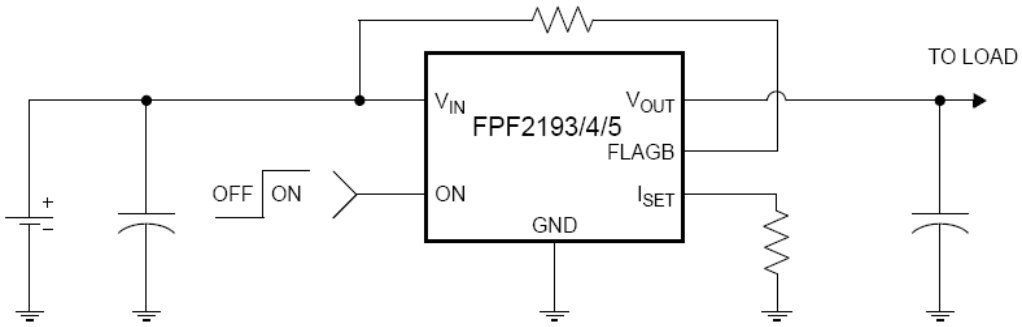

Figure 1. Typical Application

BLOCK DIAGRAM

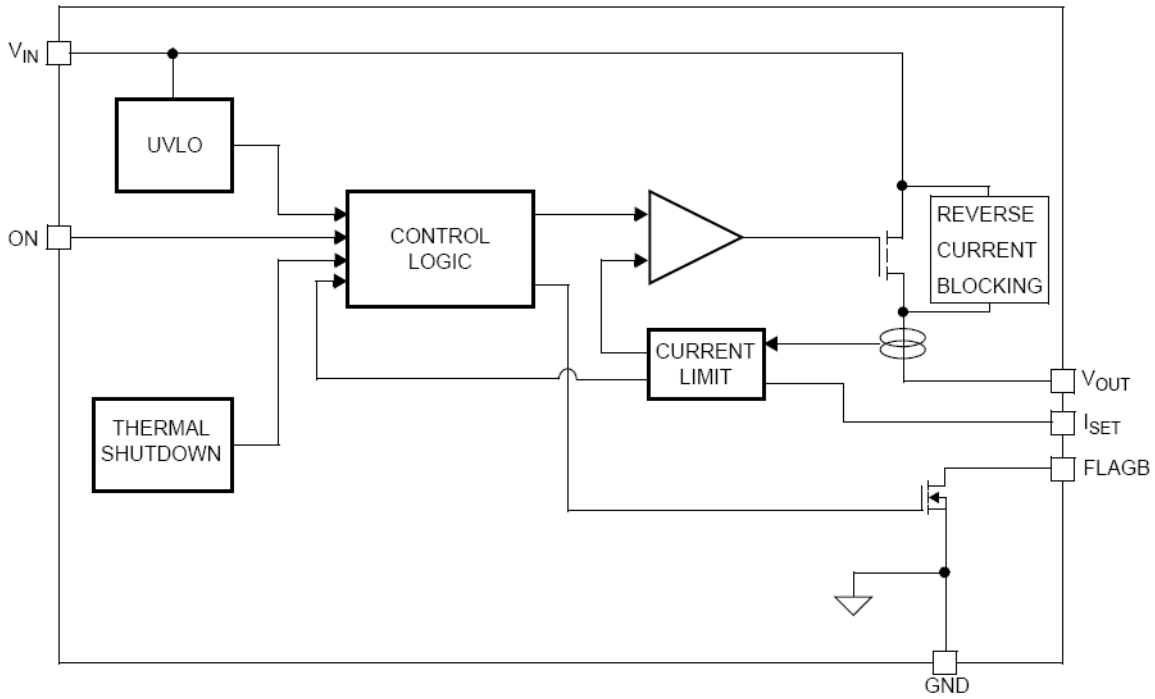

Figure 2. Functional Block Diagram

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PIN CONFIGURATION

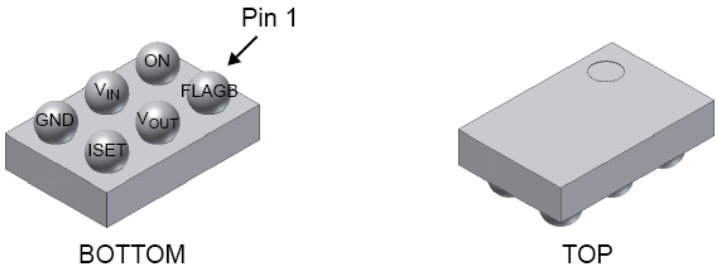

Figure 3. 1.0 x 1.5 m m Chip−Scale Package

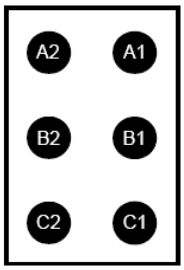

Figure 4. Pin Configuration (Bottom View)

PIN DEFINITIONS

Pin No.	Symbol	Description
C1	I_{SET}	Current Limit Set Input. A resistor from I_{SET} to ground sets the current limit for the switch.
B2	V_{IN}	Supply Input. Input to the power switch and the supply voltage for the IC.
B1	V_{OUT}	Switch Output. Output of the power switch.
A1	FLAGB	Fault Output. Active LOW, open-drain output that indicates an over-current supply, under-voltage, or over-temperature state.
C2	GND	Ground.
A2	ON	ON control input, active HIGH.

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter		Min	Max	Unit
	V_{IN}, V_{OUT}, ON, FLAGB, ISET to GND		−0.3	6.0	V
P_D	Power Dissipation at T_A = 25 °C (Note 1)		–	1.2	W
TJ	Operating Temperature Range		−40	+125	°C
T_{STG}	Storage Temperature		−65	+150	°C
Θ_{JA}	Thermal Resistance, Junction to Ambient		–	85	°C/W
ESD	Electrostatic Discharge Capability	Human Body Model, JESD22-A114	8000	–	V
		Machine Model, JESD22-A115	400	–	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Package power dissipation on one-square inch pad, two-ounce copper board.

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RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V_{IN}	Input Voltage	1.8	5.5	V
T_A	Ambient Operating Temperature	−40	+85	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

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ELECTRICAL CHARACTERISTICS (V_{IN} = 1.8 to 5.5 V, T_A = −40 to +85 °C unless otherwise noted. Typical values are at V_{IN} = 3.3 V and T_A = 25 °C.)

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
BASIC OPERATION							
V_{IN}	Operating Voltage			1.8	–	5.5	V
I_Q	Quiescent Current	I_{OUT} = 0 mA, V_{ON} = V_{IN}	V_{IN} = 1.8 V	–	70	–	μA
			V_{IN} = 3.3 V	–	75	–	
			V_{IN} = 5.5 V	–	80	–	
R_{ON}	On Resistance	T_A = 25 °C, I_{OUT} = 200 mA		–	55	80	mΩ
		T_A = −40 to 85 °C, I_{OUT} = 200 mA		–	–	135	
V_{IH}	On Input Logic High Voltage ON	V_{IN} = 1.8 V		0.8	–	–	V
		V_{IN} = 5.5 V		1.4	–	–	
V_{IL}	On Input Logic Low Voltage	V_{IN} = 1.8 V		–	–	0.5	V
		V_{IN} = 5.5 V		–	–	1.0	
I_{IN}	On Input Leakage	V_{ON} = V_{IN} or GND		−1	0	1	μA
V_{IN_SD}	V_{IN} Shutdown Current	V_{ON} = 0 V, V_{IN} = 5.5 V, V_{OUT} = Short to GND		−2	–	2	μA
V_{FLB_L}	FLAGB Output Logic Low Voltage	V_{IN} = 5 V, I_{SINK}=10 mA		–	0.05	0.20	V
		V_{IN} = 1.8 V, I_{SINK}=10 mA		–	0.12	0.30	
I_{FLB_H}	FLAGB Output Logic High Leakage Current	V_{IN} = 5 V, Switch ON		–	–	1	μA
REVERSE BLOCK							
I_{SDT}	V_{OUT} Shutdown Current	V_{ON} = 0 V, V_{OUT} = 5.5 V, V_{IN} = Short-to-GND		−2	–	2	μA
$V_{breakdown}$	Reverse Breakdown Voltage	V_{IN} = V_{ON} = 0 V, I_{OUT} = 200 μA		–	9	–	V
PROTECTIONS							
I_{LIM}	Current Limit	V_{IN} = 3.3 V, V_{OUT} = 3.0 V, R_{SET} = 690 Ω		600	800	1000	mA
	Current Limit for FPF2195BUCX	V_{IN} = 4.5 V, V_{OUT} = 4.2 V, R_{SET} = 15.8 kΩ		35	45	60	mA
$I_{LIM(MIN)}$	Minimum Current Limit	V_{IN} = 3.3 V, V_{OUT} = 3.0 V, R_{SET} = 5516 Ω		–	100	–	mA
T_{SD}	Thermal Shutdown	Shutdown Threshold		–	140	–	°C
		Return from Shutdown		–	130	–	
		Hysteresis		–	10	–	
V_{UVLO}	Under-Voltage Lockout	V_{IN} Increasing		1.55	1.65	1.75	V
V_{UVLO_HYST}	Under-Voltage Lockout Hysteresis			–	50	–	mV
DYNAMIC							
td_{ON}	Delay On Time	R_L = 500 Ω, C_L = 0.1 μF		–	20	–	μs
t_R	V_{OUT} Rise Time	R_L = 500 Ω, C_L = 0.1 μF		–	20	–	μs
t_{ON}	Turn-On Time	R_L = 500 Ω, C_L = 0.1 μF		–	40	–	μs
td_{OFF}	Delay Off Time	R_L = 500 Ω, C_L = 0.1 μF		–	15	–	μs
t_F	V_{OUT} Fall Time	R_L = 500 Ω, C_L = 0.1 μF		–	110	–	μs
t_{OFF}	Turn-Off Time	R_L = 500 Ω, C_L = 0.1 μF		–	125	–	μs
t_{BLANK}	Over-Current Blanking Time	FPF2193, FPF2194		15	30	60	ms
t_{RSTRT}	Auto-Restart	FPF2193 Only		225	450	900	ms
t_{SC}	Short-Circuit Response Time	V_{IN} = V_{OUT} = 3.3 V, Moderate Over-Current Condition		–	5	–	μs
		V_{IN} = V_{OUT} = 3.3 V, Hard Short		–	30	–	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

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TYPICAL PERFORMANCE CHARACTERISTICS

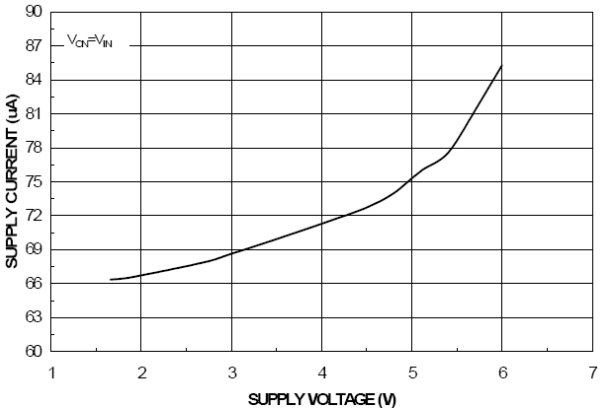

Figure 5. Quiescent Current vs. Input Voltage

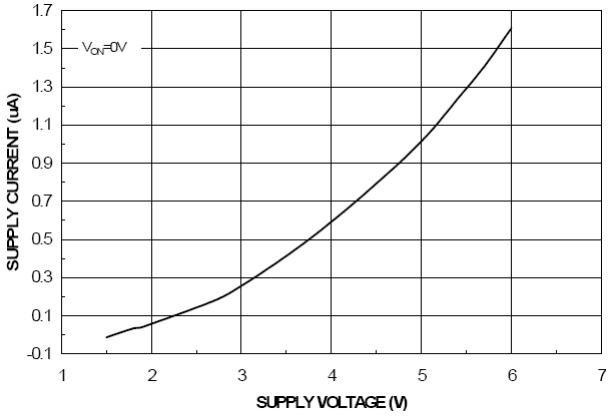

Figure 6. Quiescent Current vs. Input Voltage

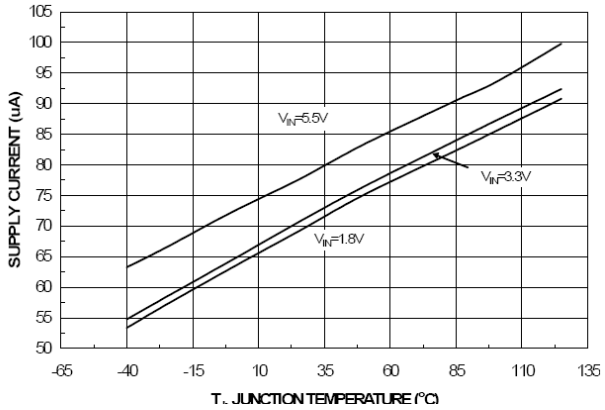

Figure 7. Quiescent Current vs. Temperature

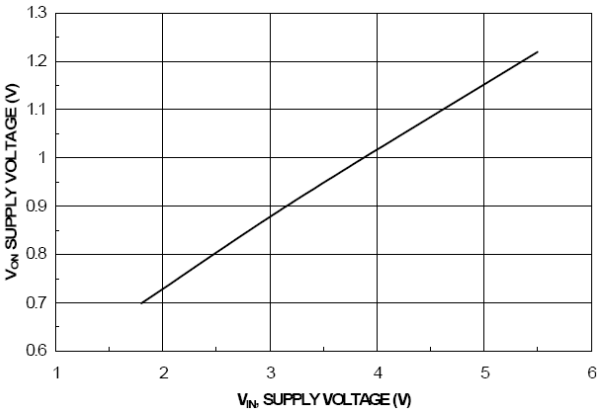

Figure 8. V_{ON} High Voltage vs. Input Voltage

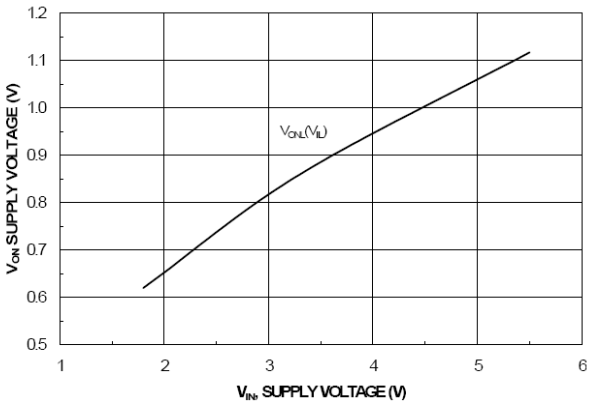

Figure 9. V_{ON} Low Voltage vs. Input Voltage

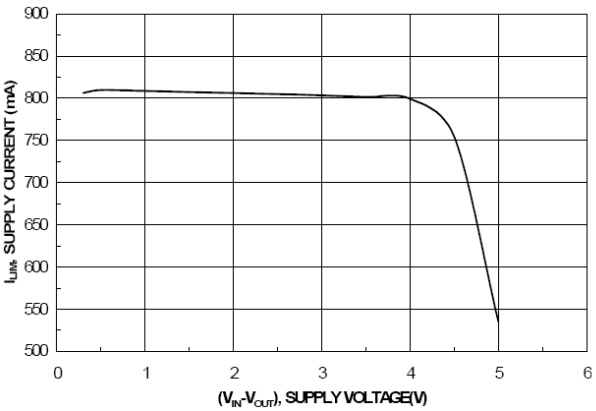

Figure 10. Current Limit vs. Output Voltage

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TYPICAL PERFORMANCE CHARACTERISTICS (CONTINUED)

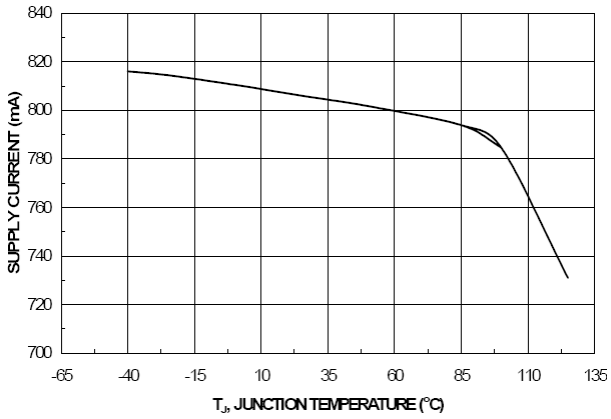

Figure 11. Current Limit vs. Temperature

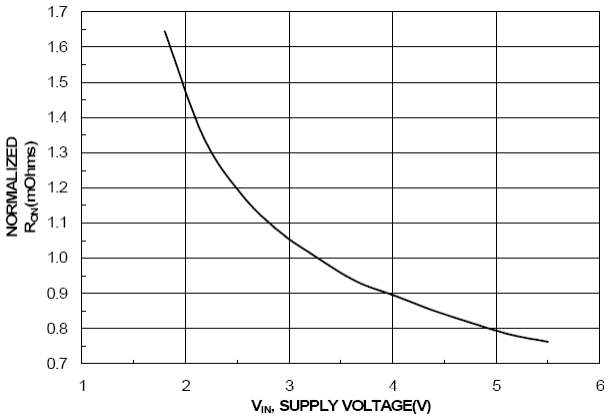

Figure 12. R_{ON} vs. V_{IN}

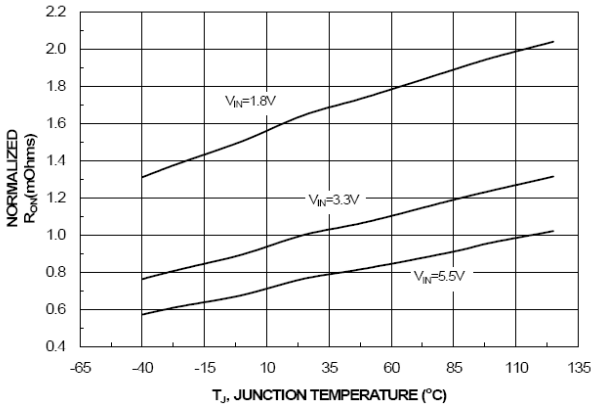

Figure 13. R_{ON} vs. Temperature

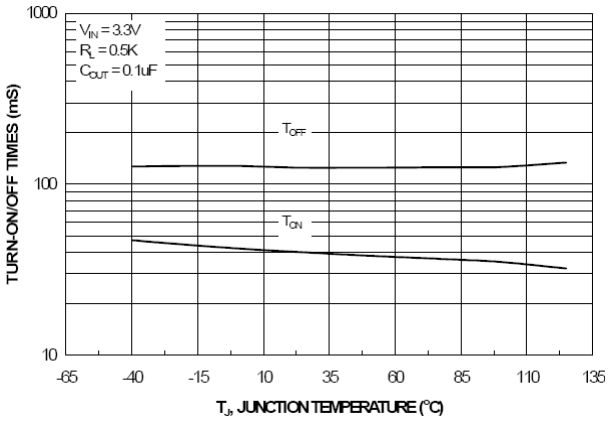

Figure 14. t_{ON} / t_{OFF} vs. Temperature

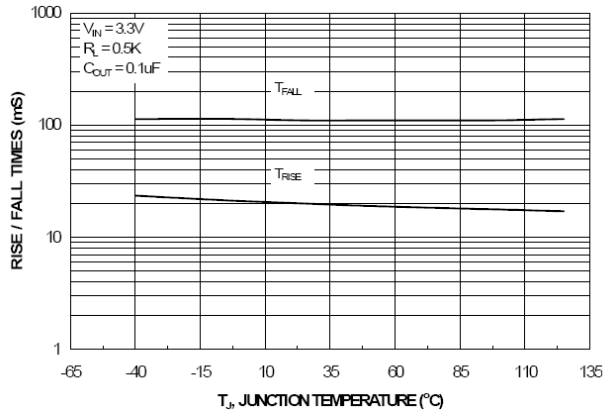

Figure 15. t_{RISE} / t_{FALL} vs. Temperature

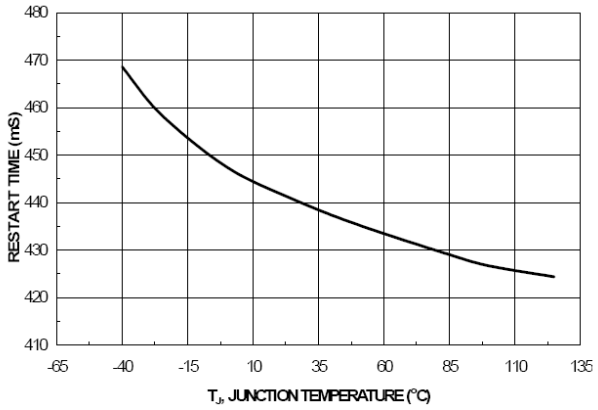

Figure 16. t_{RSTRT} vs. Temperature

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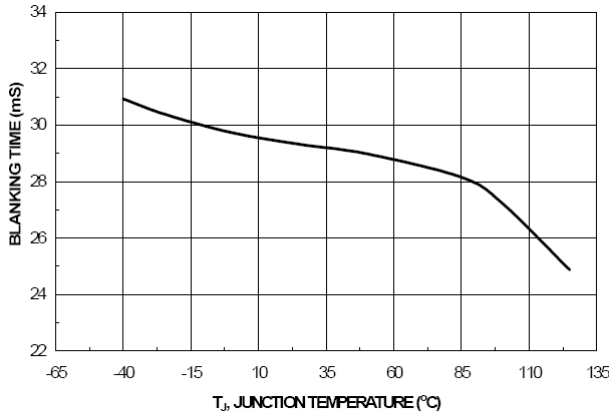

Figure 17. t_{BLANK} vs. Temperature

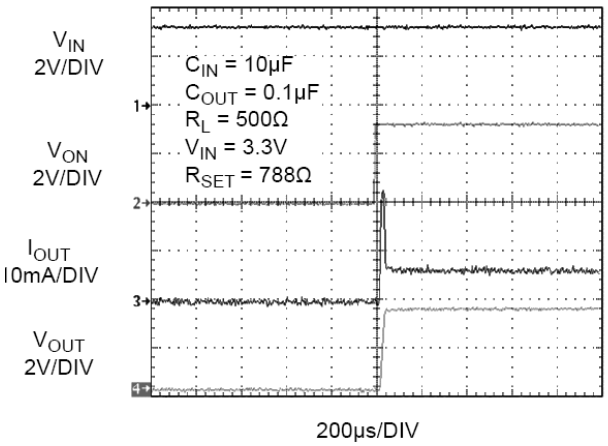

Figure 18. t_{ON} Response

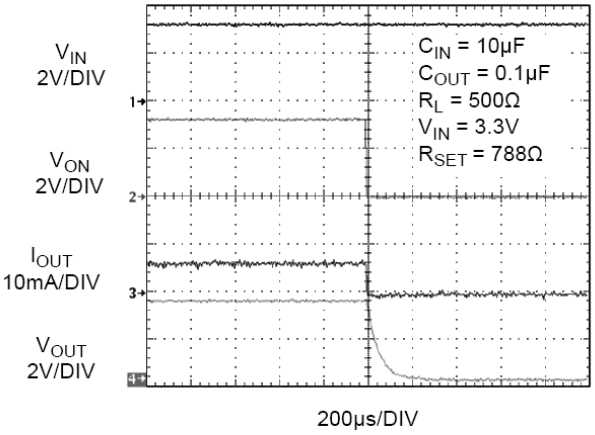

Figure 19. t_{OFF} Response

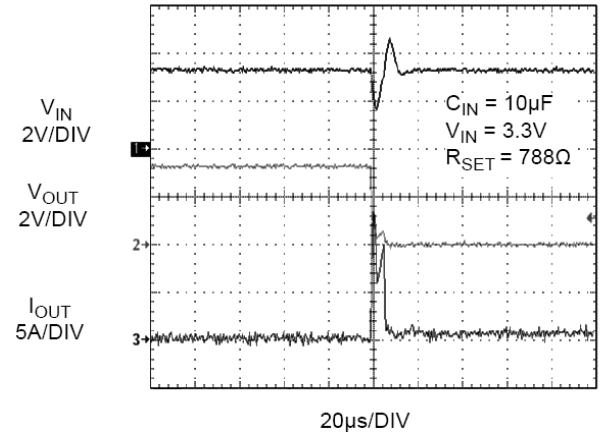

Figure 20. Short-Circuit Response Time (Output Shorted to GND)

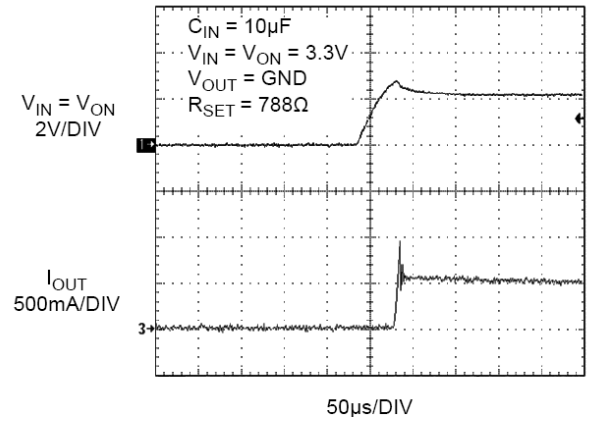

Figure 21. Current Limit Response Time (Switch is Powered into a Short)

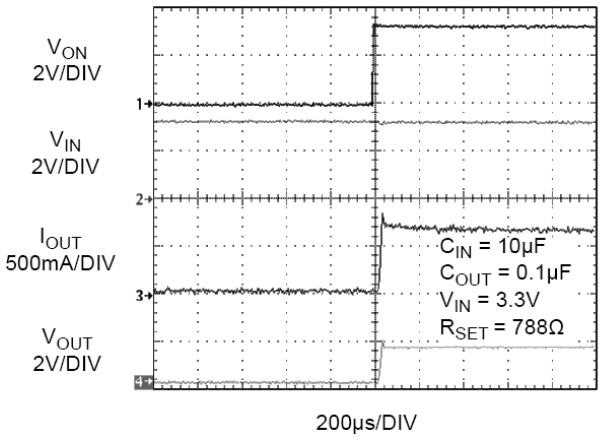

Figure 22. Current Limit Response Time (Output is Loaded by 2.2 Ω, C_{OUT} = 0.1 μF)

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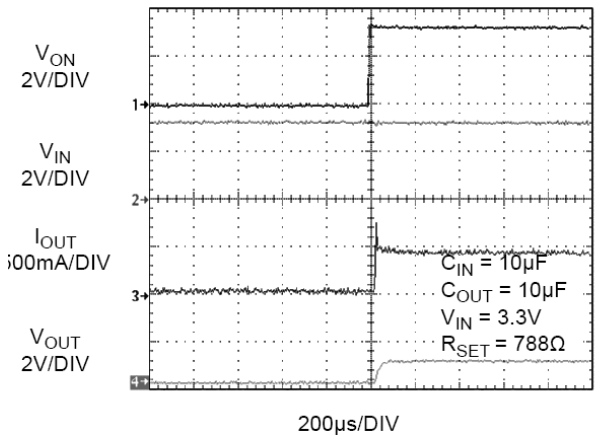

Figure 23. Current Limit Response Time (Output is Loaded by 2.2 Ω , C_{OUT} = 10 μF)

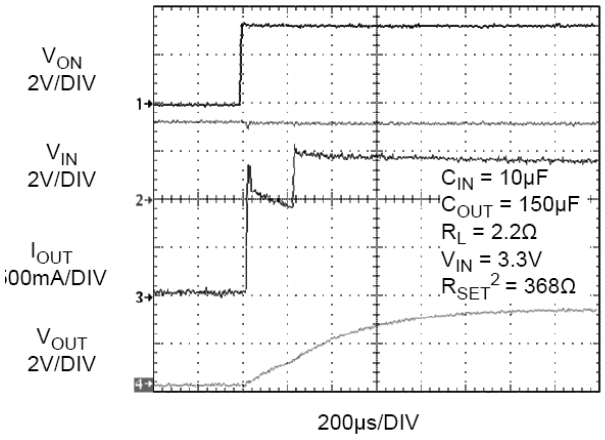

Figure 24. Short-Circuit Detection Function (Note 2)

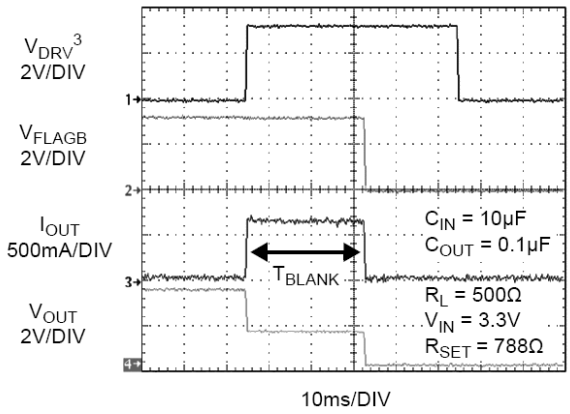

Figure 25. t_{BLANK} vs. Response (Note 3)

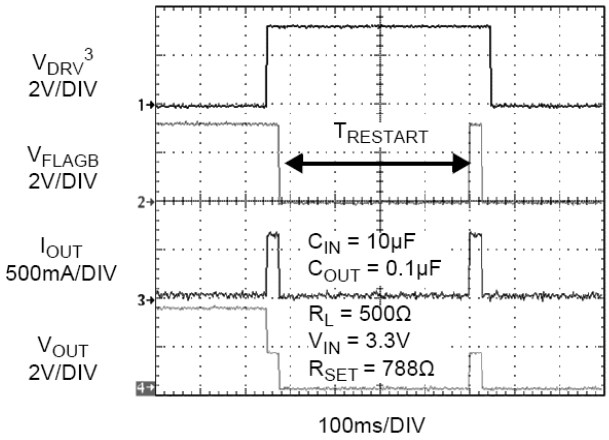

Figure 26. $t_{RESTART}$ vs. Response (Note 3)

NOTE:
2. When the output voltage is below V_{SCTH} = 1.1 V, the current limit value is set at 62.5% of the current limit value.
3. V_{DRV} signal forces the device to go into over-current condition by loading.

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FUNCTIONAL DESCRIPTION

The FPF2193, FPF2194, and FPF2195 are current-limited switches that protect systems and loads that can be damaged or disrupted by the application of high currents. The core of each device is a 55 mΩ P-channel MOSFET and a controller capable of functioning over the wide input operating range of 1.8 – 5.5 V. The controller protects against system malfunctions through current limiting, under-voltage lockout, and thermal shutdown. The current limit is adjustable from 100 mA (45 mA for FPF2195BUCX) to 1.5 A through the selection of an external resistor.

On/Off Control

The ON pin controls the state of the switch. When ON is HIGH, the switch is in ON state. Activating ON continuously holds the switch in the ON state so long as there is no fault. For all versions, an under-voltage on V_{IN} or a junction temperature in excess of 140 °C overrides the ON control to turn off the switch. In addition, excessive currents cause the switch to turn off in the FPF2193 and FPF2194. The FPF2193 has an auto-restart feature that automatically turns the switch on again after 450 ms. For the FPF2194, the ON pin must be toggled to turn the switch on again. The FPF2195 does not turn off in response to an over-current condition, but remains operating in constant-current mode as long as ON is active and the thermal shutdown or under-voltage lockout have not activated.

Fault Reporting

Upon the detection of an over-current, input under-voltage, or over-temperature condition, FLAGB signals the fault mode by activating LOW. For the FPF2193 and FPF2194, the FLAGB goes LOW at the end of the blanking time, while FLAGB goes LOW immediately for the FPF2195. FLAGB remains LOW through the auto-restart time for the FPF2195. For the FPF2194, FLAGB is latched LOW and ON must be toggled to release it. With the FPF2195, FLAGB is LOW during the faults and immediately returns HIGH at the end of the fault condition. FLAGB is an open-drain MOSFET that requires a pull-up resistor between V_{IN} and FLAGB. During shutdown, the pull-down on FLAGB is disabled to reduce current draw from the supply.

Current Limiting

The current limit ensures that the current through the switch doesn't exceed a maximum value, while not limiting at less than a minimum value. The current at which the parts limit is adjustable through the selection of an external resistor connected to I_{SET}. Information for selecting the resistor is found in the Application Information section. The FPF2193 and FPF2194 have a blanking time of 30 ms, nominally, during which the switch acts as a constant current source. At the end of the blanking time, the switch is turned off. The FPF2195 has no current limit blanking period, so it remains in a constant current state until the ON pin is deactivated or the thermal shutdown turns off the switch.

For preventing the switch from large power dissipation during heavy load, a short-circuit detection feature is introduced. Short-circuit condition is detected by, observing the output voltage. The switch is put into short-circuit current-limiting mode if the switch is loaded with a heavy load. When the output voltage drops below V_{SCTH}, the short-circuit detection threshold voltage, the current limit value is re-conditioned and the short-circuit current-limit value is decreased to 62.5% of the current limit value. This keeps the power dissipation of the part below a certain limit even at dead-short conditions at 5.5 V input voltage. The V_{SCTH} value is set to be 1 V. At around 1.1 V of output voltage, the switch is removed from short-circuit current-limiting mode and the current limit is set to the current limit value.

Under-Voltage Lockout (UVLO)

The under-voltage lockout turns the switch off if the input voltage drops below the under-voltage lockout threshold. With the ON pin active, the input voltage rising above the under-voltage lockout threshold causes a controlled turn-on of the switch, which limits current over shoot.

Thermal Shutdown

The thermal shutdown protects the die from internally or externally generated excessive temperatures. During an over-temperature condition, FLAGB is activated and the switch is turned off. The switch automatically turns on again if temperature of the die drops below the threshold temperature.

Reverse-Current Blocking

The entire FPF2193/94/95 family has a reverse current blocking feature that protects the input source against current flow from output to input. For a standard USB power design, this is an important feature to protect the USB host from being damaged due to reverse current flow on V_{BUS}.

When the load switch is OFF, no current flows from the output to the input. If the switch is turned on and the output voltage is greater than input voltage, this feature is activated and turns off the switch. This prevents any current flow from output to input. The reverse-current blocking feature is deactivated if the $V_{OUT} - V_{IN}$ is smaller than a typically 50 mV threshold. During this time, some current (50 mV/R_{ON}) flows from the output to input until input voltage becomes greater than output voltage. FLAGB operation is independent of the reverse-current blocking and does not report a fault condition if this feature is activated.

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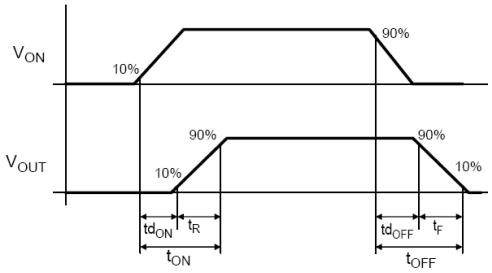

Figure 27. Timing Diagram

where:

td_{ON} = Delay On Time
t_R = V_{OUT} Rise Time
t_{ON} = Turn-On Time
td_{OFF} = Delay Off Time
t_F = V_{OUT} Fall Time
t_{OFF} = Turn-Off Time

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APPLICATION INFORMATION

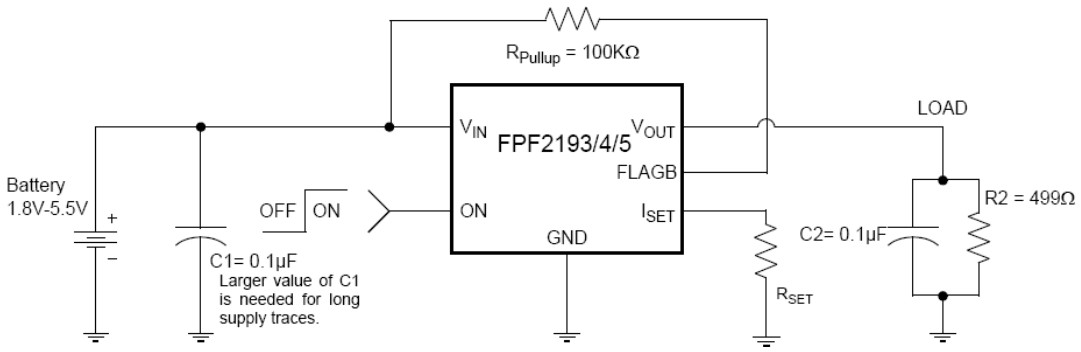

Figure 28. Typical Application

Setting Current Limit

The FPF2193, FPF2194, and FPF2195 current limit is set with an external resistor connected between I_{SET} and GND. This resistor is selected using the following equation:

$$R_{SET} = \frac{551.6}{I_{LIM}} \quad \text{(eq. 1)}$$

R_{SET} is in Ω and I_{SET} is in Amps.

Table 1 can also be used to select R_{SET}. A typical application would be the 500 mA current required by a single USB port. Using Table 1, an appropriate selection for the R_{SET} resistor would be 788 Ω. This ensures that the port load could draw 525 mA, but not more than 875 mA. Likewise for a dual-port system; an R_{SET} of 368 Ω always delivers at least 1125 mA and never more than 1875 mA.

Table 1. CURRENT LIMIT VARIOUS R_{SET} VALUES

R_{SET} (Ω)	Min. Current Limit (mA)	Typ. Current Limit (mA)	Max. Current Limit (mA)
368	1125	1500	1875
441	928	1250	1562
552	750	1000	1250
613	675	900	1125
690	600	800	1000
788	525	700	875
919	450	600	750
1103	375	500	625
1226	338	450	563
1379	300	400	500
1576	263	350	438
1839	225	300	375
2206	188	250	313
2758	150	200	250
3677	113	150	188
5516	75	100	125
15800 (Note 4)	35	45	60

4. FPF2195BUCX only.

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Input Capacitor

To limit the voltage drop on the input supply caused by transient inrush currents when the switch is turned on into a discharged load capacitor or a short-circuit, a capacitor needs to be placed between V_{IN} and GND. A 0.1 μF ceramic capacitor, C_{IN}, placed close to the pins is usually sufficient. Higher values of C_{IN} can be used to further reduce the voltage drop.

Output Capacitor

A 0.1 μF capacitor, C_{OUT}, should be placed between V_{OUT} and GND. This capacitor prevents parasitic board inductances from forcing V_{OUT} below GND when the switch turns off. For the FPF2193 and FPF2194, the total output capacitance needs to be kept below a maximum value, $C_{OUT}(max)$, to prevent the part from registering an over-current condition and turning off the switch. The maximum output capacitance can be determined from the following formula:

$$C_{OUT}(max) = \frac{I_{LIM}(max) \times t_{BLANK}(min)}{V_{IN}} \quad \text{(eq. 2)}$$

Power Dissipation

During normal operation as a switch, the power dissipated depends upon the level at which the current limit is set. The maximum allowed setting for the current limit is 1.5 A and results in a power dissipation of :

$$C_{OUT}(max) = \frac{I_{LIM}(max) \times t_{BLANK}(min)}{V_{IN}} \quad \text{(eq. 3)}$$

If the part goes into current limit, the maximum power dissipation occurs when the output is shorted to ground. For the FPF2193, the power dissipation scales by the auto-restart time, t_{RSTRT}, and the over-current blanking time, t_{BLANK}, so that the maximum power dissipated is:

$$P(max) = \frac{t_{BLANK}}{t_{BLANK} + t_{RSTRT}} \times V_{IN}(max) \times I_{LIM}(max)$$
$$= \frac{30}{30 + 450} \times 5.5 \times 1.5 = 515.6\ mW \quad \text{(eq. 4)}$$

This is more power than the package can dissipate, but the thermal shutdown of the part activates to protect the part from damage due to excessive heating. When using the FPF2194, attention must be given to the manual resetting of the part. The junction temperature is only able to increase to the thermal shutdown threshold. Once this temperature has been reached, toggling ON does not turn the switch on until the junction temperature drops. For the FPF2195, a short on the output causes the part to operate in a constant-current state, dissipating a worst-case power of:

$$P(max) = V_{IN}(max) \times I_{LIM}(max)$$
$$= 5.5 \times 1.5 = 8.25\ W \quad \text{(eq. 5)}$$

This large amount of power activates the thermal shutdown and the part cycles in and out of thermal shutdown as long as the ON pin is active and the short is present.

Board Layout

For best performance, all traces should be as short as possible. To be most effective, the input and output capacitors should be placed close to the device to minimize the effects that parasitic trace inductances may have on normal and short-circuit operation. Using wide traces for V_{IN}, V_{OUT}, and GND help to minimize parasitic electrical effects along w ith minimizing the case-to-ambient thermal impedance.

ORDERING INFORMATION

Device Order Number	Current Limit (mA)	Current Limit Blanking Time (ms)	Auto-Restart Time (ms)	ON Pin Activity	Top Mark	Package Type	Shipping†
FPF2195	100 – 1500	0	NA	Active HIGH	S9	WLCSP6 1.48x0.98x0.582 (Pb-Free)	3000 / Tape & Reel

DISCONTINUED (Note 5)

FPF2193	100 – 1500	15/30/60	225/450/900	Active HIGH	S6	WLCSP6 1.48x0.98x0.582 (Pb-Free)	3000 / Tape & Reel
FPF2194		15/30/60	NA		S7		3000 / Tape & Reel
FPF2195BUCX	45 – 1500	0S	NA	Active HIGH	SY	WLCSP6 1.48x0.98x0.582 (Pb-Free)	3000 / Tape & Reel

† For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

5. **DISCONTINUED:** These devices are not recommended for new design. Please contact your **onsemi** representative for information. The most current information on these devices may be available on www.onsemi.com.

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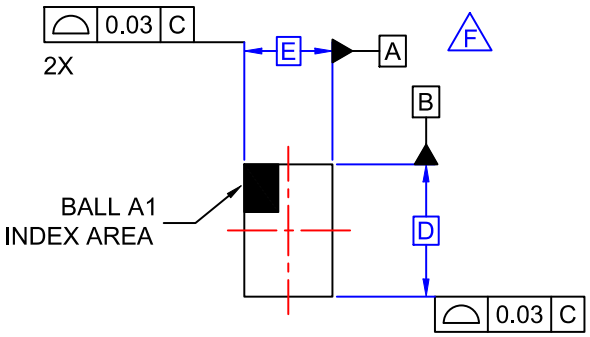
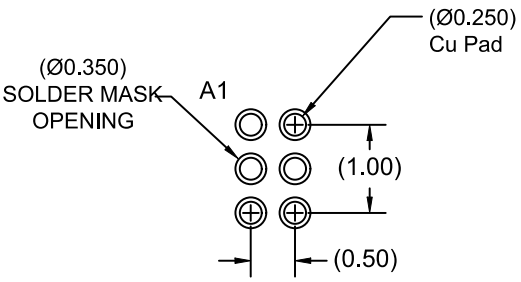
WLCSP6 1.48x0.98x0.582
CASE 567RN
ISSUE O

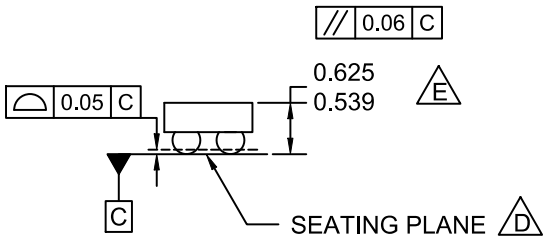
DATE 30 NOV 2016

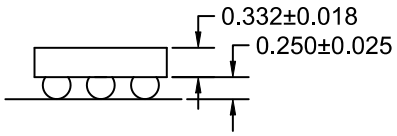


TOP VIEW

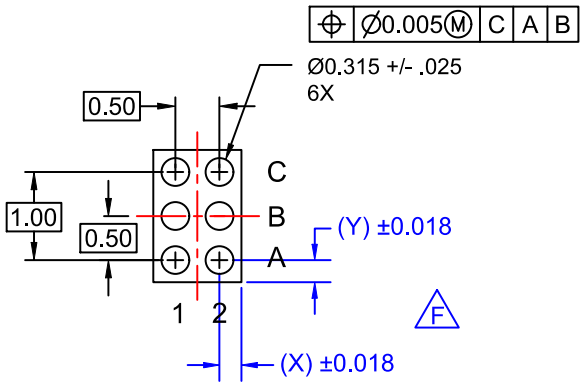


RECOMMENDED LAND PATTERN
(NSMD PAD TYPE)





SIDE VIEWS



BOTTOM VIEW

NOTES:

A. NO JEDEC REGISTRATION APPLIES.

B. DIMENSIONS ARE IN MILLIMETERS.

C. DIMENSIONS AND TOLERANCE PER ASMEY14.5M, 1994.

D. DATUM C IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.

E. PACKAGE NOMINAL HEIGHT IS 582 MICRONS ±43 MICRONS (539-625 MICRONS).

F. FOR DIMENSIONS D, E, X, AND Y SEE PRODUCT DATASHEET.

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DESCRIPTION:	**WLCSP6 1.48x0.98x0.582**	**PAGE 1 OF 1**

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